

4.1.2.6 – Appendix F: Specific PD's for Address Multiplexed ROMs (MXROM).

1.0 Introduction: This appendix describes the Presence Detects for Multiplexed ROM modules. These PD's are those referenced in the SPD standard as "Specific Features". The following PD fields will occur, in the order presented, at the point in the standard where the Specific Features are referenced; that is after the identification of the Fundamental Memory Type and before identification of whether there is any Superset Features presented. For convenience sake however, the complete address map is presented herein.

1.1 Address map: The following is the SPD address map for Multiplexed ROM. It describes where the individual LUT–Entries/ bytes will be held in the serial EEPROM:

Byte Number	Function described	Notes
0	Defines # bytes written into serial memory at module mfg	1
1	Total # bytes of SPD memory device	2
2	Fundamental memory type (FPM, EDO, SDRAM...) from appendix A	
3	# Row Addresses on this assembly	
4	# Column Addresses on this assembly	
5	# ROM Banks on this Assembly	
6	Data Width of this assembly...	
7	...Data Width continuation	
8	Voltage interface standard of this assembly	
9	Address Access Time of this assembly\$	3
10	\$Address Access Time continuation	3
11	DIMM Configuration type (Non–parity, Parity, ECC)	
12	Reserved	
13	Page Mode Access Time of this assembly	3
14	Output Enable Access Time of this assembly	3
15	Chip Enable Access Time of this assembly\$	3
16	\$Chip Enable Access Time continuation	3
17	Burst Length of this assembly	
18–31	Reserved for future offerings	
32	Superset Memory Type (may be used in future)	
33–62	Superset Memory Specific Features (may be used in future)	
63	Checksum for bytes 0–62	
64–71	Manufacturers JEDEC ID code per JEP–106	4
72	Manufacturing location	4
73–90	Manufacturer's Part Number	4
91–92	Revision Code	4
93–94	Manufacturing date	4
95–98	Assembly Serial Number	4
99–125	Manufacturer Specific Data	4
126–127	Reserved	
128–255	Open User Free–Form area\$not defined	

notes:

- 1) This will be 128 bytes for Multiplexed ROM assemblies.
- 2) This will be 256 bytes, represented as 08h. See below.
- 3) From data sheet.
- 4) Per the JEDEC spec, these are optional.

2 Bytes #0–2, For Reference: Descriptions of bytes 0–1 can be found in the main body of the SPD standard, and byte 2 is detailed in appendix A to this standard. For reference and convenience, applicable portions of their descriptions are presented again:

2.1 BYTE #0, From General SPD Standard, Number of Bytes used by Module Manufacturer: This field describes the total number of bytes used by the module manufacturer for the SPD data and any (optional) specific supplier information. The byte count includes the fields for all required and optional data.

Number SPD Bytes	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Undefined	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	1
2	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	1	1
4	0	0	0	0	0	1	0	0
5	0	0	0	0	0	1	0	1
6	0	0	0	0	0	1	1	0
7	0	0	0	0	0	1	1	1
8	0	0	0	0	1	0	0	0
9	0	0	0	0	1	0	0	1
10	0	0	0	0	1	0	1	0
11	0	0	0	0	1	0	1	1
.
.
128	1	0	0	0	0	0	0	0
.
.
254	1	1	1	1	1	1	1	0
255	1	1	1	1	1	1	1	1

2.2 Byte #1, From General SPD Standard, Total SPD Memory Size: This field describes the total size of the serial memory used to hold the Serial Presence Detect data. The following lookup table describes the possible serial memory densities (in bytes) along with the corresponding descriptor:

Serial Memory Density	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
RFU	0	0	0	0	0	0	0	0
2 Bytes	0	0	0	0	0	0	0	1
4 Bytes	0	0	0	0	0	0	1	0
8 Bytes	0	0	0	0	0	0	1	1
16 Bytes	0	0	0	0	0	1	0	0
32 Bytes	0	0	0	0	0	1	0	1
64 Bytes	0	0	0	0	0	1	1	0
128 Bytes	0	0	0	0	0	1	1	1
256 Bytes	0	0	0	0	1	0	0	0
512 Bytes	0	0	0	0	1	0	0	1
1024 Bytes	0	0	0	0	1	0	1	0
2048 Bytes	0	0	0	0	1	0	1	1
4096 Bytes	0	0	0	0	1	1	0	0
8192 Bytes	0	0	0	0	1	1	0	1
16284 Bytes	0	0	0	0	1	1	1	0
.
.
.	1	1	1	1	1	1	1	0
.	1	1	1	1	1	1	1	1

- 2.3 Byte #2, From Appendix A, Memory Type:** This byte describes the fundamental memory type (or technology) implemented on the module:

Fundamental Mem. Type	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Reserved	0	0	0	0	0	0	0	0
Standard FPM DRAM	0	0	0	0	0	0	0	1
EDO	0	0	0	0	0	0	1	0
.
Multiplexed ROM	0	0	0	0	0	1	0	1

- 3 Data Type(s):** Even though many of the PD's seem to be binary numbers representing the feature they are describing, they are considered Look Up Table (LUT) entries.
- 4** The following PD bytes are those specific to modules implementing ROM devices with a multiplexed address interface. Note that full descriptions start at byte 3 and are not covered in the main body of the SPD standard since they are specific to a given fundamental memory type/technology.

- 4.1 Byte #3, Number of ROW Addresses:** This first field describes the number of Row Addresses in the ROM array:

No. of Row Addresses	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Undefined	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	1
2	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	1	1
4	0	0	0	0	0	1	0	0
5	0	0	0	0	0	1	0	1
6	0	0	0	0	0	1	1	0
7	0	0	0	0	0	1	1	1
8	0	0	0	0	1	0	0	0
9	0	0	0	0	1	0	0	1
10	0	0	0	0	1	0	1	0
11	0	0	0	0	1	0	1	1
12	0	0	0	0	1	1	0	0
13	0	0	0	0	1	1	0	1
14	0	0	0	0	1	1	1	0
.
.
254	1	1	1	1	1	1	1	0
255	1	1	1	1	1	1	1	1

- 4.2 Byte #4, Number of COLUMN Addresses:** This field describes the number of COLUMN addresses in the module's ROM array:

Number of COLUMN Addresses	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Undefined	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	1
2	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	1	1
4	0	0	0	0	0	1	0	0
5	0	0	0	0	0	1	0	1
6	0	0	0	0	0	1	1	0
7	0	0	0	0	0	1	1	1
8	0	0	0	0	1	0	0	0
9	0	0	0	0	1	0	0	1
10	0	0	0	0	1	0	1	0
11	0	0	0	0	1	0	1	1
12	0	0	0	0	1	1	0	0
13	0	0	0	0	1	1	0	1
14	0	0	0	0	1	1	1	0

254	1	1	1	1	1	1	1	0
255	1	1	1	1	1	1	1	1

- 4.3 Byte #5, Number of Banks:** This field describes the number of banks on the ROM Module.

Number of Banks	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Undefined	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	1
2	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	1	1
4	0	0	0	0	0	1	0	0
5	0	0	0	0	0	1	0	1
6	0	0	0	0	0	1	1	0
7	0	0	0	0	0	1	1	1
8	0	0	0	0	1	0	0	0
9	0	0	0	0	1	0	0	1
10	0	0	0	0	1	0	1	0
11	0	0	0	0	1	0	1	1
12	0	0	0	0	1	1	0	0
13	0	0	0	0	1	1	0	1
14	0	0	0	0	1	1	1	0

254	1	1	1	1	1	1	1	0
255	1	1	1	1	1	1	1	1

- 4.4 Bytes 6 & 7, Module Data Width:** Bytes 6 and 7 are used to designate the modules data width. The data width is presented as a 16 bit word; bit 0 of byte 6 becomes the LSB of the 16 bit width identifier and bit7 of byte 7 becomes the MSB. Consequently, if the module has a width of less than 255 bits wide, byte 7 will be 00h. If the data width is 256 bits or higher, byte 7 is used in conjunction with byte 6 to designate the total module width. For example, if the module's data width is:

64	0000 0000	0100 0000
72	0000 0000	0100 1000
80	0000 0000	0101 0000
576	0000 0010	0100 0000

4.4.1 Byte 6:

Data Width	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Undefined	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	1
2	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	1	1
.
.
32	0	0	1	0	0	0	0	0
.
36	0	0	1	0	0	1	0	0
.
.
64	0	1	0	0	0	0	0	0
.
72	0	1	0	0	1	0	0	0
.
.
128	1	0	0	0	0	0	0	0
.
144	1	0	0	1	0	0	0	0
.
.
254	1	1	1	1	1	1	1	0
255	1	1	1	1	1	1	1	1

- 4.4.2 Byte #7, Module Data Width Continued:** This byte will be left at 00h if the original module data width is less than 256 bits wide. If the width is more than 255, then this byte will be used in conjunction with byte 6.

Module Data Width Cont.	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0(+)	0	0	0	0	0	0	0	0
256(+)	0	0	0	0	0	0	0	1
512(+)	0	0	0	0	0	0	1	0
1024(+)	0	0	0	0	0	0	1	1
2048(+)	0	0	0	0	0	1	0	0
.
.

- 4.5 Byte #8, Module Interface Levels:** This field describes the module's voltage interface:

Voltage Interface	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
5.0 Volt/TTL	0	0	0	0	0	0	0	0
LVTTL	0	0	0	0	0	0	0	1
HSTL 1.5	0	0	0	0	0	0	1	0
SSTL 3.3	0	0	0	0	0	0	1	1
SSTL 2.5	0	0	0	0	0	1	0	0
TBD	0	0	0	0	0	1	0	1
TBD	0	0	0	0	0	1	1	0
.
.
New Table	1	1	1	1	1	1	1	1

- 4.6 Bytes #9 & #10, Address Access Time (t_{AA}):** Bytes 9 and 10 are used to designate the address access time of the module. This access time is presented as a 16 bit word; bit 0 of byte 9 becomes the LSB of the 16 bit access time identifier and bit 7 of byte 10 becomes the MSB. Consequently, if the module has an address access time of less than 256ns, byte 10 will have a value of 00h. If the address access time is 256ns or greater, byte 10 is used in conjunction with byte 9 to designate the total access time.

4.6.1 Byte 9:

Address Access Time (LSB)	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Reserved	0	0	0	0	0	0	0	0
1 (+x0A) ns	0	0	0	0	0	0	0	1
2 (+x0A) ns	0	0	0	0	0	0	1	0
–	–	–	–	–	–	–	–	–
–	–	–	–	–	–	–	–	–
254 (+x0A) ns	1	1	1	1	1	1	0	1
255 (+x0A) ns	1	1	1	1	1	1	1	1
.
.
New Table	1	1	1	1	1	1	1	1

- 4.6.2 Byte #10, Address Access Time Continued:** This byte will be left at 00h if the address access time of the module is less than 256 nanoseconds. If the address access time of the module is 256 nanoseconds or greater, byte 10 is used in conjunction with byte 9 to determine the access time of the assembly.

Address Access Time (MSB)	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0 (+x09) ns	0	0	0	0	0	0	0	0
256 (+x09) ns	0	0	0	0	0	0	0	1
512 (+x09) ns	0	0	0	0	0	0	1	0
1024 (+x09) ns	0	0	0	0	0	0	1	1
2048 (+x09) ns	0	0	0	0	0	1	0	0
4096 (+x09) ns	0	0	0	0	0	1	0	1
8192 (+x09) ns	0	0	0	0	0	1	1	0
16384 (+x09) ns	0	0	0	0	0	1	1	1
–	–	–	–	–	–	–	–	–

- 4.7 Byte #11, Module Configuration type:** This field describes the module's error detection and or correction schemes:

Error Det/Cor	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
None	0	0	0	0	0	0	0	0
Parity	0	0	0	0	0	0	0	1
ECC	0	0	0	0	0	0	1	0
TBD	0	0	0	0	0	0	1	1
TBD	0	0	0	0	0	1	0	0
TBD	0	0	0	0	0	1	0	1
TBD	0	0	0	0	0	1	1	0
.
.
TBD	1	1	1	1	1	1	1	1

- 4.8 Byte #12, Reserved:** This byte is reserved for future offerings.

- 4.9 Byte #13, Page Mode Access Time (t_{PA}):** Byte 13 represents the page mode access time from chip enable of the device (t_{PA}) in nanoseconds.

Page Mode Access Time	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Reserved	0	0	0	0	0	0	0	0
1 ns	0	0	0	0	0	0	0	1
2 ns	0	0	0	0	0	0	1	0
–	–	–	–	–	–	–	–	–
–	–	–	–	–	–	–	–	–
253 ns	1	1	1	1	1	1	0	1
254 ns	1	1	1	1	1	1	1	0
New Table	1	1	1	1	1	1	1	1

- 4.10 Byte #14, Output Enable Access Time (t_{OE}):** Byte 14 represents the access time from output enable of the device (t_{OE}) in nanoseconds.

Output Enable Access Time	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Reserved	0	0	0	0	0	0	0	0
1 ns	0	0	0	0	0	0	0	1
2 ns	0	0	0	0	0	0	1	0
–	–	–	–	–	–	–	–	–
–	–	–	–	–	–	–	–	–
253 ns	1	1	1	1	1	1	0	1
254 ns	1	1	1	1	1	1	1	0
New Table	1	1	1	1	1	1	1	1

- 4.11 Bytes #15 & #16, Chip Enable Access Time (t_{OE}):** Bytes 15 and 16 are used to designate the access time from chip enable of the module. This access time is presented as a 16 bit word; bit 0 of byte 15 becomes the LSB of the 16 bit access time identifier and bit 7 of byte 16 becomes the MSB. Consequently, if the module has a chip enable access time of less than 256ns, byte 16 will have a value of 00h. If the chip enable access time is 256ns or greater, byte 16 is used in conjunction with byte 15 to designate the total chip enable access time.

4.11.1 Byte #15:

Chip Enable Access Time (LSB)	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Reserved	0	0	0	0	0	0	0	0
1 (+x0F) ns	0	0	0	0	0	0	0	1
2 (+x0F) ns	0	0	0	0	0	0	1	0
–	–	–	–	–	–	–	–	–
–	–	–	–	–	–	–	–	–
254 (+x0F) ns	1	1	1	1	1	1	0	1
255 (+x0F) ns	1	1	1	1	1	1	1	1

- 4.11.2 Byte #16, Chip Enable Access Time Continued:** This byte will be left at 00h if the chip enable access time of the module is less than 256 nanoseconds. If the chip enable access time of the module is 256 nanoseconds or greater, byte 16 is used in conjunction with byte 15 to determine the chip enable access time of the assembly.

Chip Enable Access Time (MSB)	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0 (+x0F) ns	0	0	0	0	0	0	0	0
256 (+x0F) ns	0	0	0	0	0	0	0	1
512 (+x0F) ns	0	0	0	0	0	0	1	0
1024 (+x0F) ns	0	0	0	0	0	0	1	1
2048 (+x0F) ns	0	0	0	0	0	1	0	0
4096 (+x0F) ns	0	0	0	0	0	1	0	1
8192 (+x0F) ns	0	0	0	0	0	1	1	0
16384 (+x0F) ns	0	0	0	0	0	1	1	1
–	–	–	–	–	–	–	–	–

- 4.12 Byte #17, Burst Length:** Byte 17 is an 8 bit mask which indicates all burst lengths supported by the device. If a bit in byte 17 is “1” then the associated burst length is supported by the module. If the bit is “0”, then that burst length is not supported.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Burst Length = Page	TBD	TBD	TBD	Burst Length 8	Burst Length 4	Burst Length 2	Burst Length 1
1 or 0	1 or 0	1 or 0	1 or 0	1 or 0	1 or 0	1 or 0	1 or 0

- 4.13 Bytes 18–31:** Open. There are no defined PD settings for these bytes.

- 4.14 Bytes 32 through 62, Superset information:** If a superset technology is developed and is completely backward compatible, it may be specified and its SPD may be defined in bytes 32 through 62.

- 4.15 Byte 63, Checksum for bytes 0–62:** The Checksum will be calculated using the procedure defined in the SPD General Standard, Sec. 4.1.2, Pars. 4.3 & 5.7.

- 5 From the general SPD standard:** The descriptions of bytes 64–127 are repeated here For Reference ONLY. Manufacturers MAY include information which is pertinent to their particular modules, place and date of manufacture, etc. If a module manufacturer decides to write data into bytes 64–127, they must follow the format and order presented below. If a module manufacturer chooses not to include the data outlined below, they must leave bytes 64–127 unprogrammed; blank state of these bytes may be 00h or FFh. Detailed implementation of bytes 64–127 is detailed below in paragraphs 5.X:

- 5.1 Bytes 64–71, Manufacturers ID code per EIA/JEP106.** Manufacturers of a given module may include their identifier per Jedec spec JEP106. 00h is not allowed and FFh indicated continuation. The first byte is utilized, the second byte filling. Unused locations/bytes should be FFh.
- 5.2 Byte 72, Manufacturing Location.** Manufacturers may include an identifier which uniquely defines the manufacturing location of the memory module. While the SPD spec will not attempt to present a decode table for manufacturing sites, the individual manufacturer may keep track of manufacturing location and its appropriate decode represented in this byte.
- 5.3 Bytes 73–90, Manufacturer's Part Number:** Manufacturers may include their part number in 6–bit ASCII format within these bytes.
- 5.4 Bytes 91–92, Revision Code:** This refers to the module revision code. While the SPD spec will not attempt to define the format for this information, the individual manufacturer may keep track of the revision code and its appropriate decode represented in this byte.
- 5.5 Bytes 93–94, Date of Module Manufacture:** The module manufacturer may include a date code for the module. Specifically, byte 93 may contain the year in Binary and byte 94 may contain the week in Binary.
- 5.6 Bytes 95–98, Module Serial Number:** The supplier may include a serial number for module. The supplier may use whatever decode method desired to maintain a unique serial number for each module.
- 5.7 Bytes 99–125, Manufacturers specific data, open area:** The module manufacturer may add any additional information desired into the module within these locations.
- 5.8 Bytes 126–127, Reserved:** These bytes are reserved and cannot be later allocated.